

Express Mail No.: EL046033654US
IBM Docket No.: BUR920000141US

PATENT

JC872 U.S. PTO
09/892954
06/27/01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR: Nicole S. Carpenter et al.

SERIAL NO.:

FILING DATE:

FOR:

CLEANING OF
SEMICONDUCTOR
WAFERS BY
CONTAMINATE
ENCAPSULATION

EXAMINER:

ART UNIT:

DATE:

Markoff
1746

SAH
#2
8.28.01

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
BOX PATENT APPLICATION
Washington, D.C. 20231

Dear Sir:

In accordance with 37 CFR 1.56, 1.97 and 1.98, the following items are made of record to assist the Patent & Trademark Office in its examination of this application and is, in the opinion of the attorney designated below for applicant(s), information relevant to the closest prior art of which that person is aware. The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made or that no other art than that identified exists.

PATENT NO.

3,958,292
5,690,749
5,753,563
5,902,678

INVENTOR

Powell
Lee
Guan et al.
Konda et al.

ISSUE DATE

May 25, 1976
November 25, 1997
May 19, 1998
May 11, 1999

BEST AVAILABLE COPY

Express Mail No.: EL046033654US
IBM Docket No.: BUR920000141US

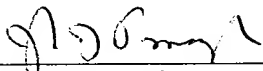
-2-

<u>FOREIGN PAT. NO.</u>	<u>COUNTRY</u>	<u>PUBLICATION DATE</u>
06260464 A	Japan	September 16, 1994
07142440 A	Japan	June 2, 1995
JP9260326 A2	Japan	October 3, 1997

A copy of each of the foregoing items and Form PTO 1449 are enclosed herewith.

Respectfully submitted,

By:


Attorney: **John J. Tomaszewski**
Reg. No.: **26,241**

~~DELIO & PETERSON, LLC
121 Whitney Avenue
New Haven, CT 06510
(203) 787-0595~~

~~CERTIFICATE OF MAILING UNDER 37 CFR 1.10~~

~~I hereby certify that, on the date shown below, this correspondence is being deposited with the United States Postal Service in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231, as "Express Mail Post Office to Addressee"~~

~~Mailing Label No. _____ on _____~~

~~Name of person mailing paper _____~~

~~Signature _____~~

~~Date: _____~~

~~ibmb100321000ids1~~

BEST AVAILABLE COPY